Tool ID: 803 Tool Location: 111

Glass Substrates

PECVD and ALD Films

Soft organic materials

Exposed Gold, Silver, Copper Alkali and Alkaline Compounds

Equipment Information Sheet

Dicing Tape Frame Applicator

Manager:Sam Wright607-254-4836Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times leave a message or send them an email.

SAFETY

• Use caution when cutting tape with razor blade.

Allowed

USAGE RESTRICTIONS SCHEDULING/SIGN-UP RESTRICTIONS

Tool category 1/1E, 2, 3, and 4 materials
Silicon Based Substrates and Films
III/V compound Semiconductors

Cured organics and baked Photoresist CNF Class A, B, and Refractory metals

MATERIALS COMPATIBILITY CATEGORY

Minimum Tool Time: 0 minutes

EGONT	
Tool Category 5: Class A and B Metals and Compounds	
	Not Allowed
erials	
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tals	

Some tool restrictions on high vapor pressure materials may apply

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

Additional Material Restrictions and Exceptions

Organic/Biology Molecules prepared-w/salt buffers
High Vapor Pressure Materials (Mg, Ca, Zn)*

Last Updated: 11/29/2018